

THREE QUADRANT TRIACS

Blocking voltage - 800 Volts On-state RMS current - 16.0 Ampere

FEATURES

- ◆ Ultra low gate trigger current
- ◆ Low cost package

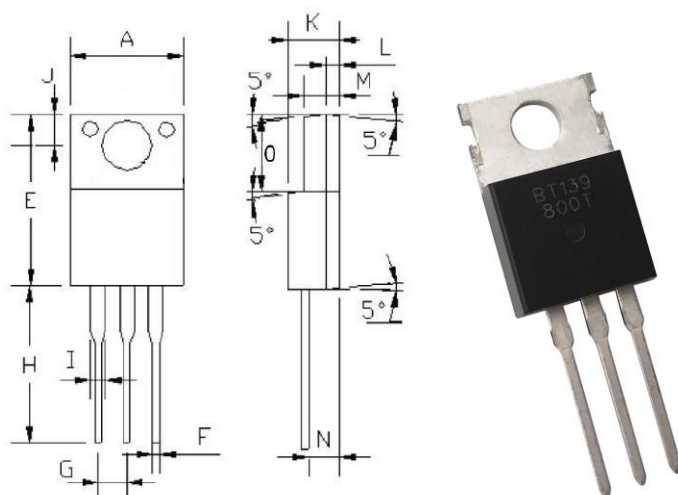
APPLICATIONS

- ◆ Typical applications include motor control, industrial and domestic lighting, heating and static switching
- ◆ Heating regulation
- ◆ Motor control
- ◆ Phase control

DESCRIPTION

Glass passivated high commutation triacs in a full pack, plastic envelope intended for use in circuits where high static and dynamic dV/dt and high dI/dt can occur. These devices will commutate the full rated rms current at the maximum rated junction temperature, without the aid of a snubber.

TO-220F



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min	Max	Min	Max		Min	Max	Min	Max
A	0.396	0.404	10.050	10.250	J	0.123	0.131	3.130	3.330
E	0.618	0.630	15.700	16.000	K	0.182	0.186	4.630	4.730
F	0.028	0.035	0.700	0.900	L	0.030(TYP.)		0.77(TYP.)	
G	0.093	0.108	2.350	2.750	M	0.097	0.101	2.470	2.570
H	0.500	0.512	12.700	13.000	N	0.104	0.112	2.650	2.850
I	0.049	0.057	1.240	1.440	O	0.258	0.262	6.550	6.650

PINNING INFORMATION

PIN	Description	Simplified outline	Symbol
1	main terminal 1(T1)		
-	-		
3	Gate(G)		

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX	UNIT
V_{DRM} V_{RRM}	Repetitive peak off-state voltages	800	V
$I_{T(RMS)}$	RMS on-state current	16	A
I_{TSM}	Non-repetitive peak on-state current	120	A

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
$R_{th\ j-mb}$	Thermal resistance junction to mounting base	full cycle	-	-	1.5	K/W
		half cycle	-	-	2.0	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient	in free air	-	60	-	K/W

Kingtronics®**BT139 800T****THREE QUADRANT TRIACS****Blocking voltage - 800 Volts On-state RMS current - 16.0 Ampere****LIMITING VALUE**

Limiting values in accordance with the Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT	
$I_{T(RMS)}$	RMS on-state current	full sine wave; $T_{mb} \leq 102\text{ }^{\circ}\text{C}$	-	16	A	
	Non-repetitive peak on-state current	full sine wave; $T_j = 25\text{ }^{\circ}\text{C}$ prior to surge	$t = 20\text{ ms}$	-	120	A
			$t = 16.7\text{ ms}$	-	140	A
I^2t	I^2t for fusing	$t = 10\text{ ms}$	-	45	A^2s	
di_T/dt	Repetitive rate of rise of on-state current after triggering	$I_{TM} = 16\text{ A}$; $I_G = 0.2\text{ A}$; $DI_G/dt = 0.2\text{ A/s}$	T2+ G+	-	100	$\text{A}/\mu\text{s}$
			T2- G-	-	100	$\text{A}/\mu\text{s}$
I_{GM}	Peak gate current		-	2	A	
V_{GM}	Peak gate voltage		-	8	V	
P_{GM}	Peak gate power		-	16	W	
$P_{G(AV)}$	Average gate power	over any 20 ms period	-	0.35	W	
T_{sta}	Storage temperature		-40	150	$^{\circ}\text{C}$	
T_j	Junction temperature		-40	125	$^{\circ}\text{C}$	

CHARACTERISTICS $T_j = 25\text{ }^{\circ}\text{C}$ unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT	
Static characteristics							
I_{GT}	Gate trigger current	$V_D = 12\text{ V}$; $I_T = 0.1\text{ A}$	T2+ G+	-	10	35	mA
			T2+ G-	-	15	35	mA
			T2- G-	-	15	35	mA
I_L	Latching current	$V_D = 12\text{ V}$; $I_{GT} = 0.1\text{ A}$	T2+ G+	-	20	50	mA
			T2+ G-	-	30	80	mA
			T2- G-	-	20	50	mA
I_H	Holding current	$V_D = 12\text{ V}$; $I_{GT} = 0.15\text{ A}$	-	20	40	mA	
V_T	On-state voltage	$I_T = 20\text{ A}$	-	-	1.85	V	
V_{GT}	Gate trigger voltage	$V_D = 12\text{ V}$; $I_T = 0.1\text{ A}$	T2+ G+	0.5	0.78	1.5	V
			T2+ G-	0.5	0.70	1.5	V
			T2- G-	0.5	0.71	1.5	V

Dynamic Characteristics

dV_D/dt	Critical rate of rise of off-state voltage	$V_{DM} = 67\% V_{DRM(max)}$; $T_j = 125\text{ }^{\circ}\text{C}$; Exponential wave form; gate open circuit	250	500	-	$\text{V}/\mu\text{s}$
di_{com}/dt	Critical rate of change of commutating current	$V_D = 400\text{ V}$; $T_j = 125\text{ }^{\circ}\text{C}$ $I_{T(RMS)} = 4.4\text{ A}$; Commutating $dV/dt = 18\text{ V/s}$, Without snubber; gate open circuit	6.5	-	-	A/ms
di/dt	Repetitive Critical Rate of Rise of On-State Current	$I_{PK} = 50\text{ A}$; $PW = 40\text{ sec}$; $di_G/dt = 200\text{ mA/set}$; $f = 60\text{ Hz}$	-	-	10	$\text{A}/\mu\text{s}$

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RATINGS AND CHARACTERISTIC CURVES BT139 800T

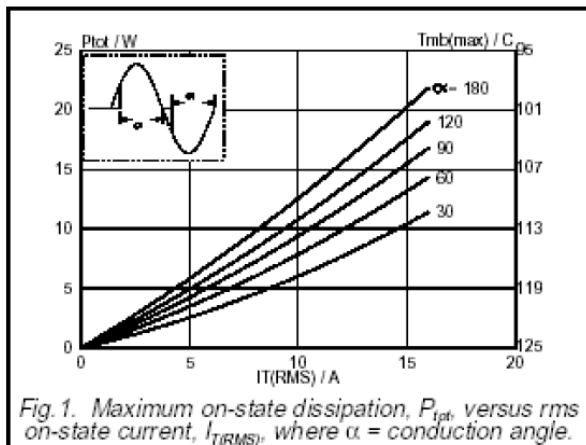


Fig. 1. Maximum on-state dissipation, P_{opt} , versus rms on-state current, $I_{T(RMS)}$, where $\alpha =$ conduction angle.

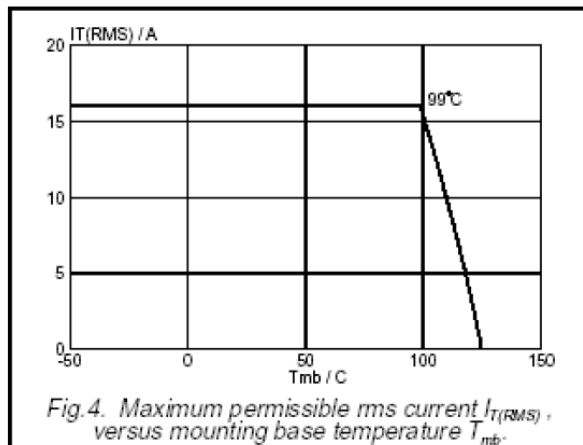


Fig. 4. Maximum permissible rms current $I_{T(RMS)}$, versus mounting base temperature T_{mb} .

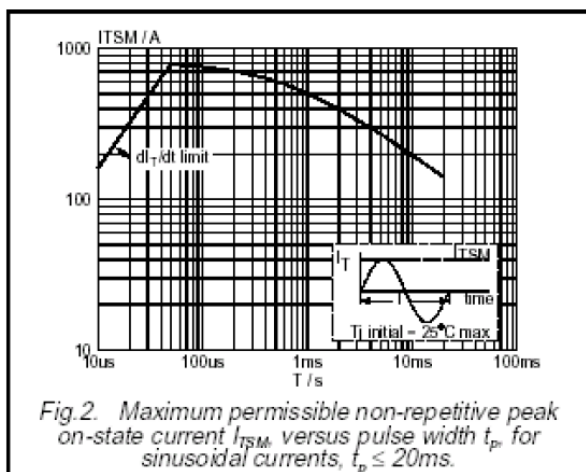


Fig. 2. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus pulse width t_p for sinusoidal currents, $t_p \leq 20$ ms.

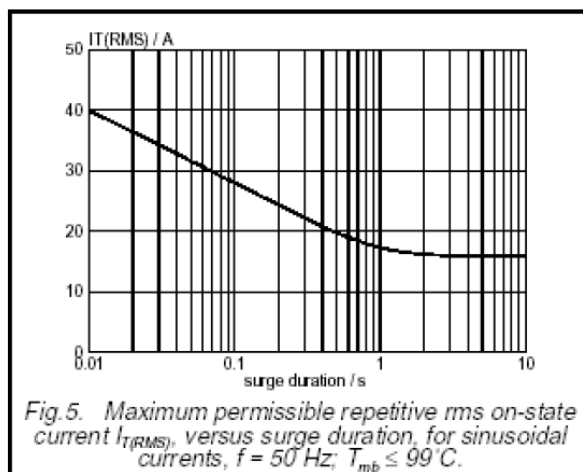


Fig. 5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, $f = 50$ Hz; $T_{mb} \leq 99$ °C.

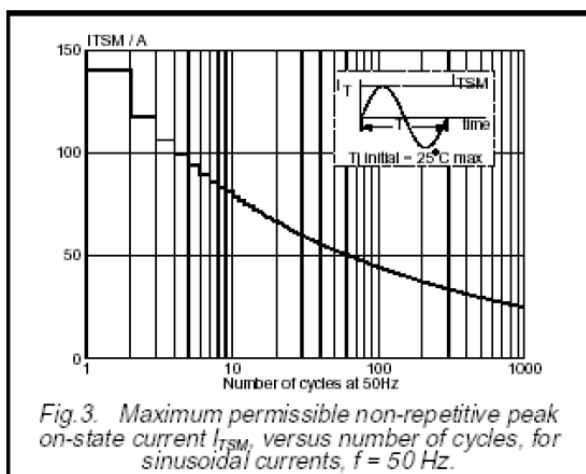


Fig. 3. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus number of cycles, for sinusoidal currents, $f = 50$ Hz.

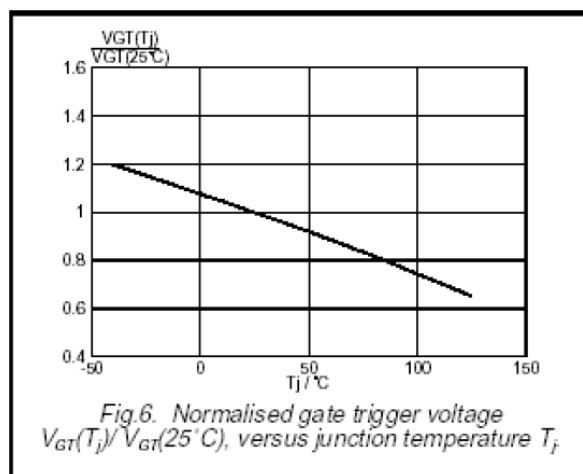
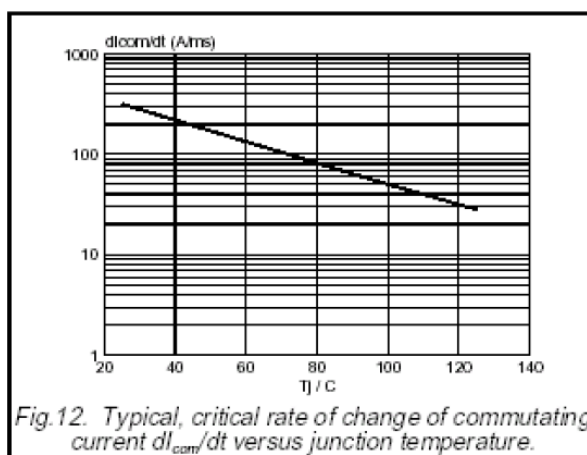
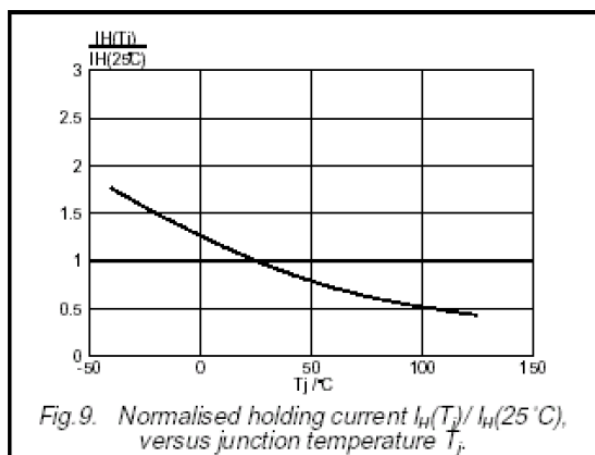
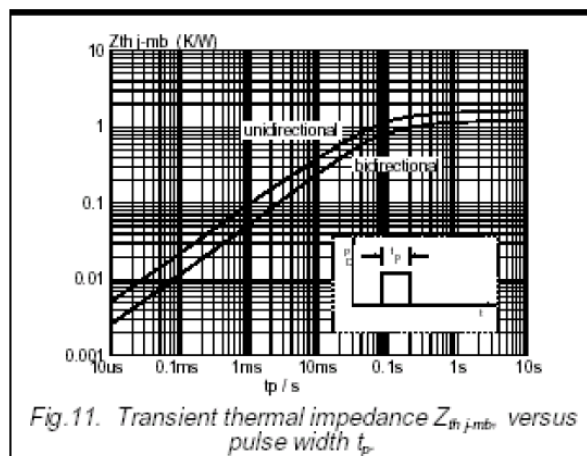
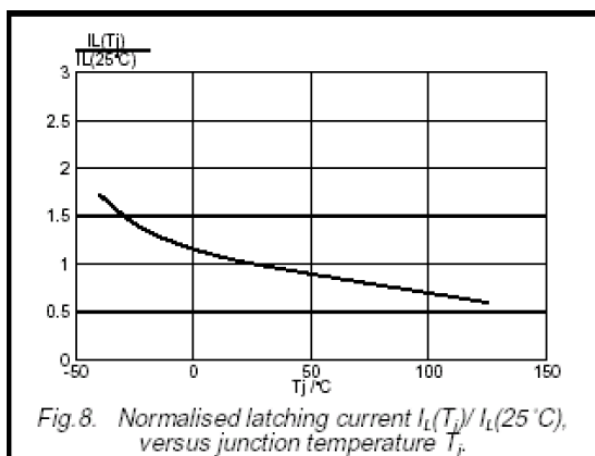
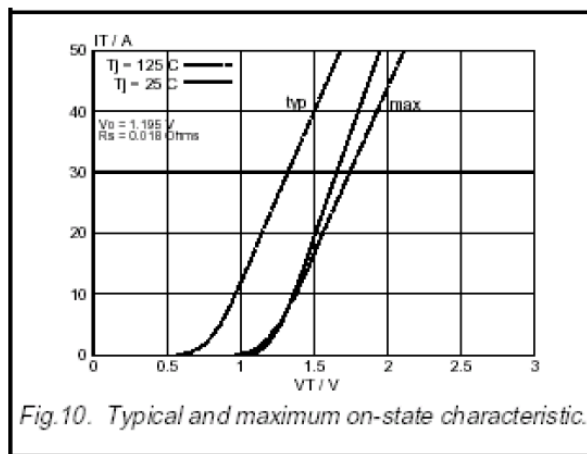
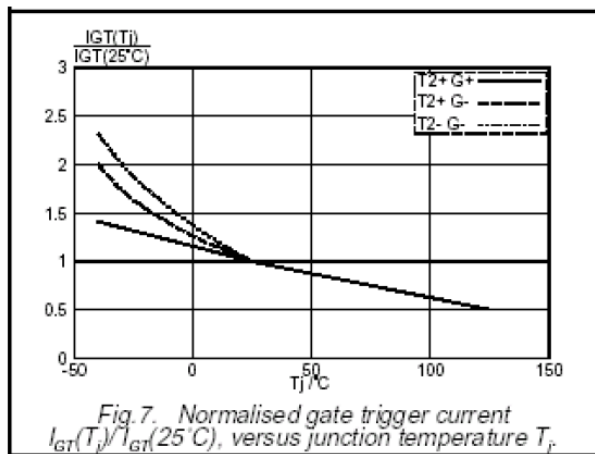


Fig. 6. Normalised gate trigger voltage $V_{GT}(T_j)/V_{GT}(25^\circ C)$, versus junction temperature T_j .

Note: Specifications are subject to change without notice.

RATINGS AND CHARACTERISTIC CURVES BT139 800T



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